# **UM74HCT612**

LING

**Memory Mapper** 

#### Features

- Fully compatible with TTL, NMOS and CMOS devices.
- Expands 4 address lines to 12 address lines.

### **General Description**

The UM74HCT612 essentially contains a 4-line to 16-line decoder and a 16-word by 12-bit RAM. It is designed to expand a microprocessor's memory address capability by 8 bits (from 4 to 12). That is, four bits of the memory address bus can be used to select one of 16 map registers that contain 12 bits each. These 12 bits are presented to the system memory address bus along with the unused memory address bit from the CPU. By periodically reloading the mapper registers from the data bus, one can access any of the 16 pages of memory.

There are four modes of operation (read, write, map, and pass). When  $\overline{CS}$  (Chip Select) is active low, through  $D0 \sim D7$ , data may be read from or written into the map register selected by the register select inputs (RS0  $\sim$  RS3) under

## **Pin Configuration**

#### **Block Diagram**



\*NC: Not connected.

MULTI-MM RSØ~ HS3 140 DDRESS 16 x 12 BAN Č\$ MULTI 12 RAW CONTROL SATING OUT STROBE D0~D11 DATA

Designed for paged memory mapping.

High-current 3-state outputs.

the control of R/W.

When  $\overline{CS}$  is high and  $\overline{MM}$  (Map Mode Control) is active low, the map operation will output the contents of map register selected by the map address input (MA0 ~ MA3),

When  $\overline{\text{CS}}$  and  $\overline{\text{MM}}$  are both high (pass mode), the address bit on MA0 ~ MA3 appears at MO8 ~ MO11, respectively, with the other bits forcing low level. MO0 ~ MO7 are low.

All outputs are tri-state outputs with high current capability. The STROBE input is used to enter data into selected map register during 1/O operation. Map outputs are enabled by the  $\overline{ME}$  input.



# Absolute Maximum Ratings\*

D.C. Supply Voltage, V <sub>DD</sub>	0.5V to 7V
(	respect to V <sub>SS</sub> )
Input Voltage V <sub>I</sub>	0.5V to 7V
Operating Temperature	0°C to 70°C
Storage Temperature	–65°C to 150°C
Maximum Power Dissipation	0.1W

#### \*Comments

Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only. Functional operation of this device at these or any other conditions above those indicated in the operational sections of this specification is not implied and exposure to absolute maximum rating conditions for extended periods may affect device reliability.

# **D.C. Electrical Characteristics**

 $(V_{DD} = 5V \pm 10\%, T_A = 0^{\circ}C \sim 70^{\circ}C)$ 

Symbol	Parameter	Min.	Тур.	Max.	Unit	Condition
V <sub>DD</sub>	Power Supply	4.5	5	5.5	v	Recommended
VIH	Input High-Level Voltage	2.0	-	-	V	Recommended
VIL	Input Low-Level Voltage	-	-	0.8	V	Recommended
V <sub>оно</sub>	Output High-Level Voltage on D0 ~ D11	4.4	4.9	-	v	I <sub>OH</sub> = -20 μA
		3.8	4.0	=	V	I <sub>OH</sub> = -6.0 mA
V <sub>онм</sub>	Output High-Level Voltage on MO0~MO11	4.4	4.9	_	V	Ι <sub>ΟΗ</sub> = -20 μΑ
		3.8	4.3	-	V	I <sub>OH</sub> = -8.0 mA
V <sub>old</sub>	Output Low-Level Voltage on D0 ~ D11	-	0.001	0.1	V	I <sub>OL</sub> = 20 μA
		-	0.3	0.4	V	I <sub>OL</sub> = 12 mA
V <sub>OLM</sub>	Output Low-Level Voltage on MO0 ~ MO11	-	0.001	0.1	V	Ι <sub>ΟL</sub> = 20 μΑ
		-	0.4	0.5	V	I <sub>OL</sub> = 20 mA
I IN	Input Current	- 1.0	-	1.0	μА	$V_{IN} = 5V \sim 0V$
I <sub>OZ</sub>	OFF-State Output Current	-5	-	5	μΑ	$V_0 = 3V \sim 0V$
<sup>I</sup> cc	Steady Current	-	-	10	μA	V <sub>IN</sub> = V <sub>DD</sub> or 0V, No Load.



# Timing Requirement and Switching Characteristics: $(V_{DD} = 5V \pm 10\%, T_A = 0^{\circ}C \text{ to } 70^{\circ}C)$

Parameter	Min.	Тур.	Max.	Unit	Condition	
Pulse Width of STROB: Tsbw	75	_	_	ns	Recommended Value	
CS Setup Time: Tcssu (CS low to STROB low)	20	-	_	ns	Recommended Value	
R/W Setup Time: Trwsu (R/W low to STROB low)	20	-	-	ns	Recommended Value	
RS Setup Time: <u>Trssu</u> (RS valid to <u>STROB</u> low)	20	-	-	ns	Recommended Value	
DATA Setup Time: Tdasu (D0-D11 valid to STROB high)	75	-	-	ns	Recommended Value	
CS Hold Time: Tcshd (STROB high to CS high)	20	-	-	ns	Recommended Value	
R/W Hold Time: Trwnd (STROB high to R/W high)	20	-	-	ns	Recommended Value	
RS Hold Time: Trshd (STROB high to RS invalid)	20	_	-	ns	Recommended Value	
DATA Hold Time: Tdahd (STROB high to D0 – D11 invalid)	20	-	-	ns	Recommended Value	
RS to D0-D11: TRSDV (TpHL or TpLH)	-	39	75	ns		
CS↓ to D0 – D11: TCLDV (TpZL or TpZH)	-	26	50	ns	Figure 1 with	
CS↑ to D0-D11, disable: TCHDZ (TpHZ or TpLZ)	-	38	65	ns	RL = 1K, CL = 50P <sub>f</sub> Timing Diagram see Figure 6.	
R/W 1 to D0 - D11: TWHDV (TpZL or TpZH)	-	20	35	ns		
R/₩↓ to D0 – D11, disable: TWLDZ (TpHZ or TpLZ)	-	30	50	ns		
CS T to MO0-MO11. TCHQ (TpHL or TpLH)	-	48	85	ns		
MM↓to MO0-MO11: TMLQ (TpHL or TpLH)	-	20	40	ns		
MM T to MO0-MO11: TMHQ (TpHL or TpLH)	-	22	40	ns	Figure 1 with	
MA to MO0-MO11, MM = low: TAVQ1 (TpHL or TpLH)	-	39	70	ns	RL = 1K; CL = 50P <sub>f</sub> Timing Diagram see Figure 7.	
MA to MO8-MO11, MM = high: TAVQ2 (TpHL or TpLH)	-	13	-30	ns		
ME↓ to MO0-MO11: TELQ (TpZL or TpZH)	-	17	30	ns		
ME 1 to MO0-ME11, disable: TEHOZ (TpHZ or TpLZ)	-	14	25	ns		

Note: See Figures 2, 3, 4, and 5, for definitions of TpLH, TpHL, TpHZ, TpLZ, TpZH, TpZL.



# **Pin Description**

Symbol	Description
D0-D11	I/O connection to data and control bus. Used for reading from or writing into the map register.
RS0-RS3	Register select inputs for I/O operation.
R/W	Read or write control pin used in I/O operation. When low, data bus is used to write into register. When high, data bus is used to read from register.
STROB	Strobe input. Used to enter data into register.
CS	Chip select input. When low, the Read and Write Modes are active.
MA0-MA3	Inputs to select one of 16 registers, when in map mode.
M00-M011	Map outputs. Present the map register contents to the system memory address bus in the map mode. When in pass mode, these outputs provide the map address data on MO8 – MO11 and low level on MO0–MO11.
MM	Map mode input. When low, the map mode is active; when high, it is in pass mode.
ME	Map output enable pin. When low, outputs MO0-MO11 are active. When high, these are high impedance.

# **Function Table**

CS	MM	R/W	STROBE	Operation
0	×	0	0	Write Mode, D0 ~ D7 ⇒ Selected Register.
0	×	1	×	Read Mode, Selected Register ⇒ D0 ~ D7.
1	0	x	×	Map Mode, Register Contents $\Rightarrow$ MO0 ~ MO11 (If $\overline{ME}$ = 0).
1	1	×	x	Pass Mode. $MA0 \sim MA3 \Rightarrow MD8 \sim MD11$ and $MD0 \sim MD7$ are all low (If $\overline{ME} = 0$ ).

Parameter Measurements 3-State Output







#### Set-Up and Rise, Fall Times





# **Pulse Duration**



Figure 3

### **Delay Times**





#### Enable or Disable







# **Timing Waveforms**

# Read and Write Mode



Figure 6

#### Map and Pass Mode



Figure 7